

Typical Applications

The HMC141C8 is ideal for:

- Microwave Point-to-Point Radios
- VSAT Ground Equipment

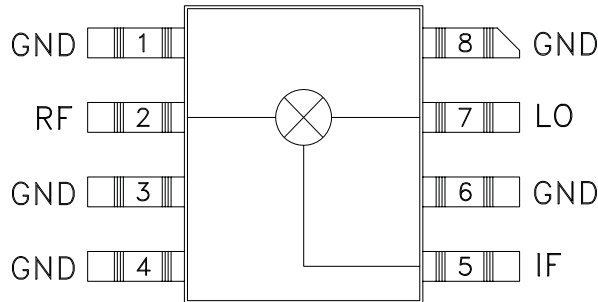
Features

Input IP3: +21 dBm

Conversion Loss: 8.5 dB

LO to RF Isolation: 35 dB

Functional Diagram



General Description

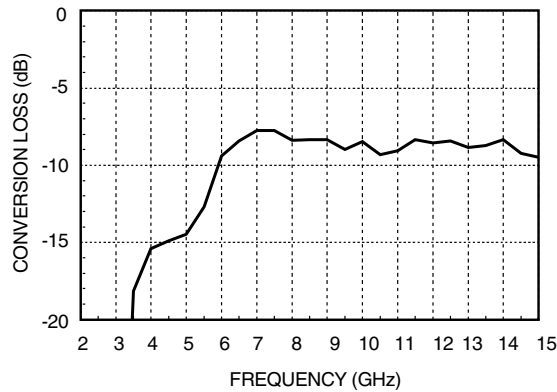
The HMC141C8 is a miniature passive double-balanced mixer in a non-hermetic ceramic surface mount package that can be used as an upconverter or downconverter. The device is a passive diode/balun type mixer with high dynamic range. The mixer can handle larger signal levels than most active mixers due to the high third order intercept of 20 dBm. MMIC implementation provides exceptional balance in the circuit resulting in high LO/RF and LO/IF isolations and unit-to-unit consistency. This mixer has applications where small size and surface mount compatibility are important.

Electrical Specifications, $T_A = +25^\circ \text{C}$, LO Drive = +15 dBm

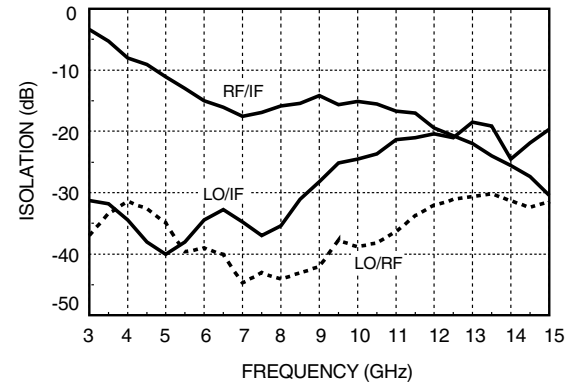
Parameter	Min.	Typ.	Max.	Min.	Typ.	Max.	Units
Frequency Range, RF & LO	7 - 10			6 - 14.4			GHz
Frequency Range, IF	DC - 2			DC - 2			GHz
Conversion Loss		8.5	10		10.5	12.5	dB
Noise Figure (SSB)		8.5	10		10.5	12.5	dB
LO to RF Isolation	28	35		23	30		dB
LO to IF Isolation	17	25		10	17		dB
IP3 (Input)		20			20		dBm
IP2 (Input)		45			45		dBm
1 dB Gain Compression (Input)		10			10		dBm

GaAs MMIC SMT DOUBLE-BALANCED MIXER, 6 - 15 GHz

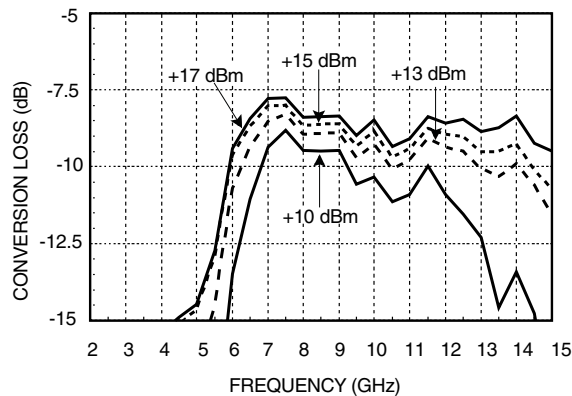
Conversion Loss



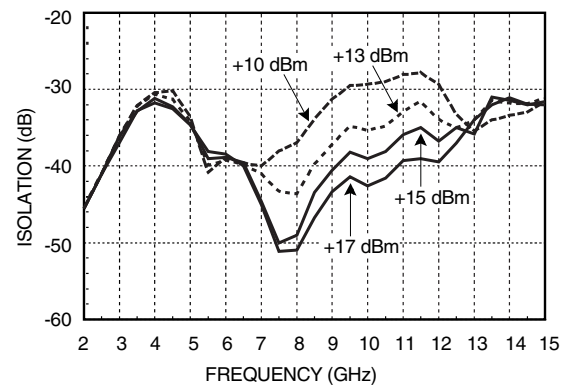
Isolation



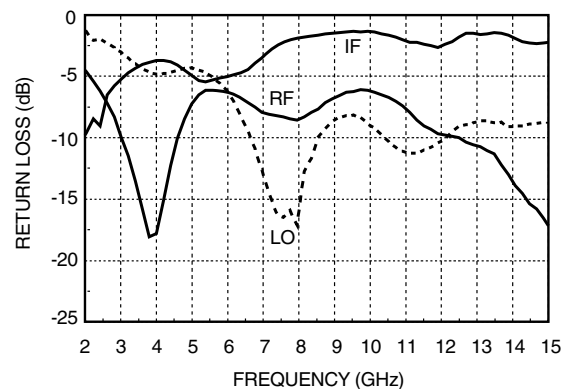
Conversion Loss vs. LO Power



Isolation vs. LO Drive Level



Return Loss

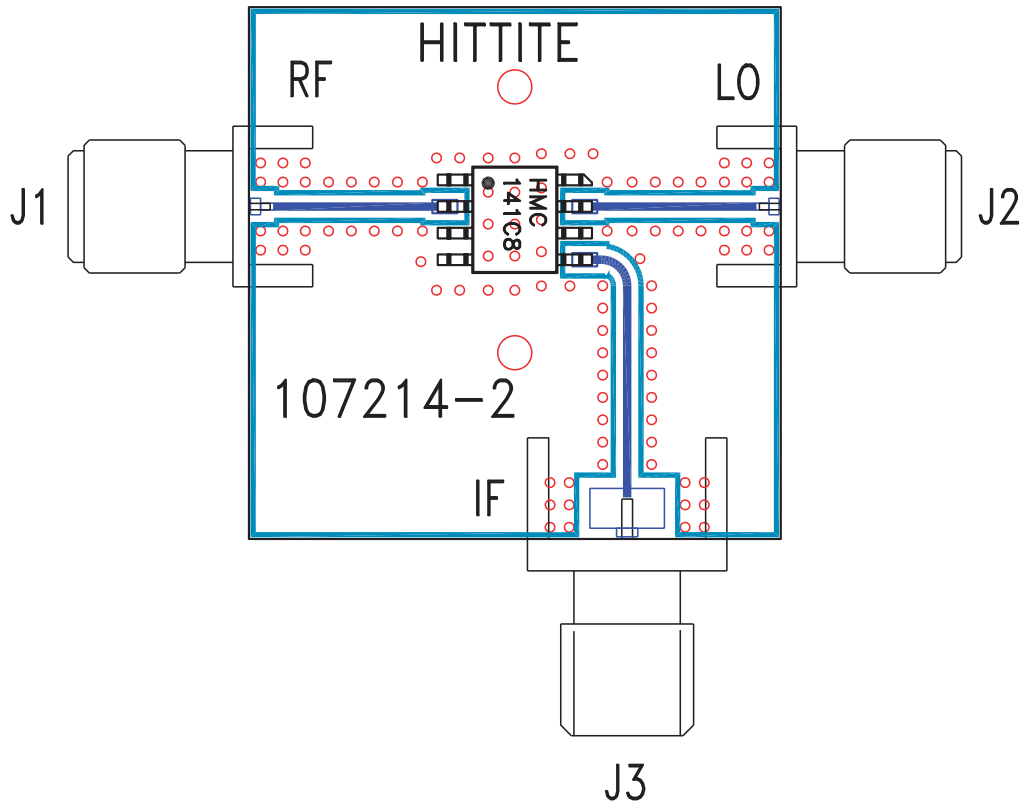


Distortion and 1dB

Compression vs. LO Drive Level

LO Drive (dBm)	Distortion		
	IP3 (dBm)	IP2 (dBm)	P1dB (dBm)
+13	18	42	7
+15	21	45	10
+17	21	45	10

Evaluation PCB



List of Materials for Evaluation PCB 102102 ^[1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
U1	HMC141C8 Mixer
PCB [2]	107214 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.